

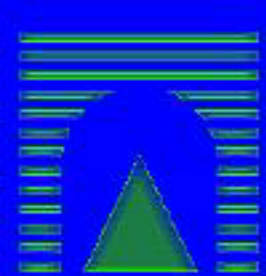
# Intermixing-promoted scaling of self-assembled island sizes : the Ge/Si(100) system.

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## Outline

- Ge/Si(100) self assembling in the SK growth mode:
  - Evolution of morphology and strain
  - Parameter definitions
- The role of the deposition temperature:
  - Evidence for a Ge-Si intermixing
  - Island size scaling with the actual misfit

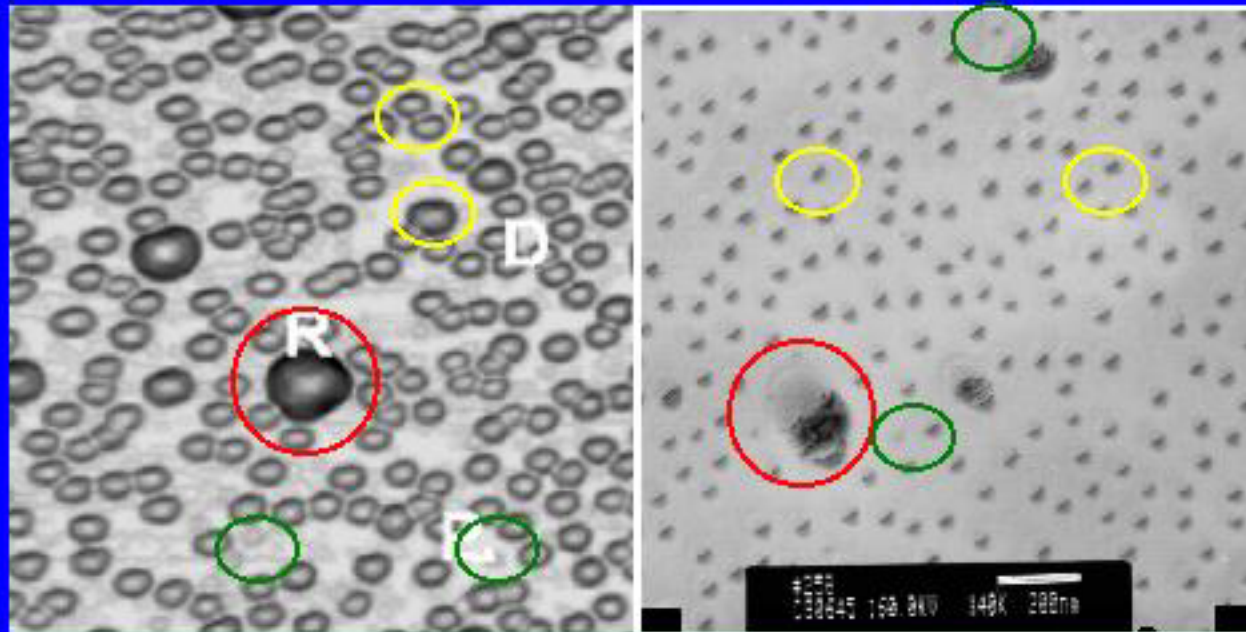


# Ge/Si(100) self assembling

We can correlate the structural to morphological properties

Differential AFM  $1 \times 1 \mu\text{m}^2$

TEM  $1 \times 1 \mu\text{m}^2$



$T_{\text{dep}} = 600^\circ\text{C}$   
 $\theta = 12 \text{ ML}$   
UHV-CVD

Plastically relaxed domes (interrupted Moiré pattern)

Strained multifaceted domes (steeper)

Strained pyramids

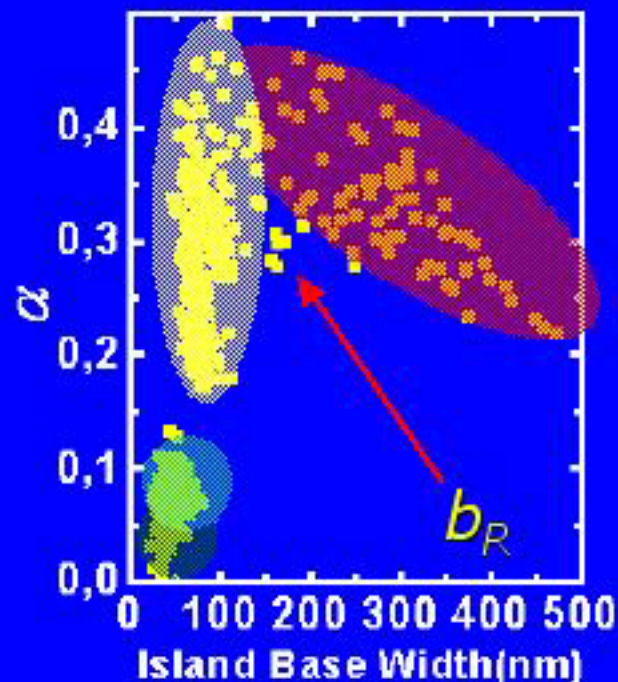
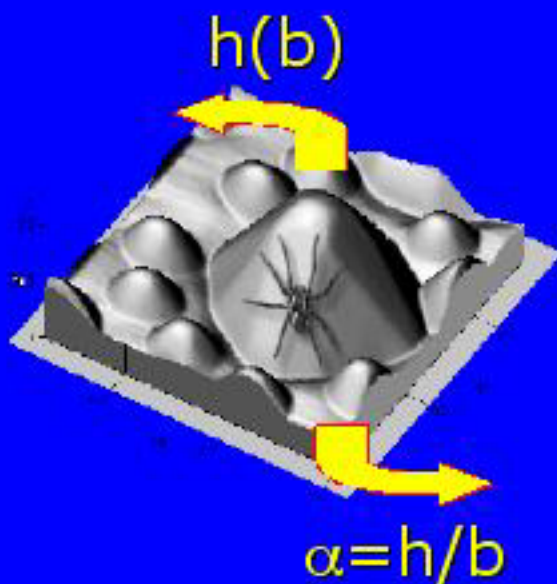
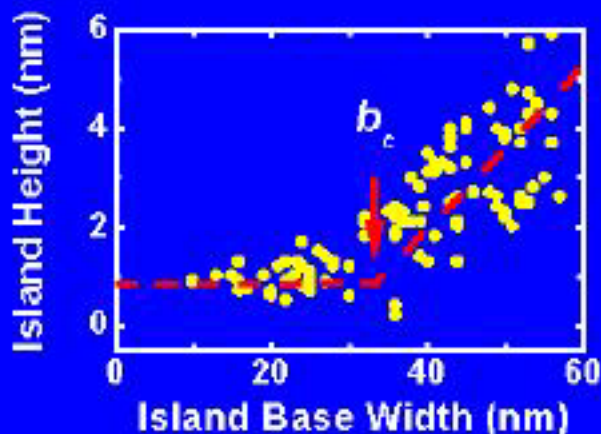
Platelets (precursors, not detectable this scale)

} Moiré pattern spacing  $\Delta$

011

# Ge/Si(100) self assembling

Defining quantitative parameters of the growth



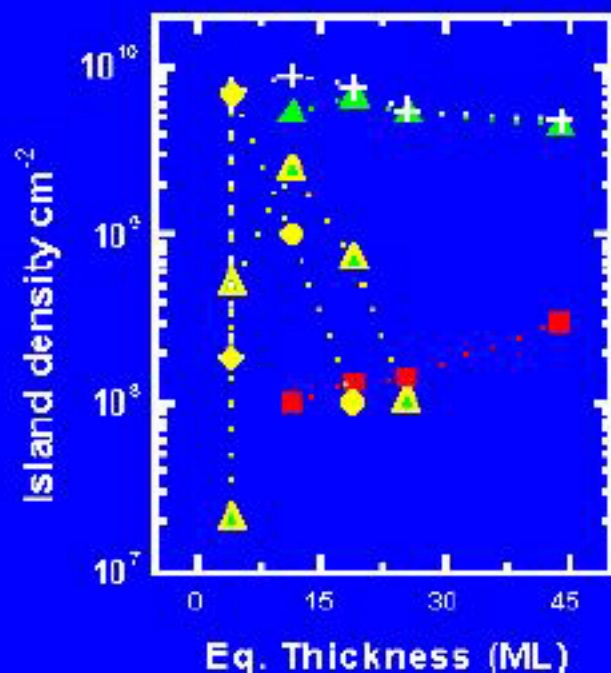
( $F = 10$  ML/min  $T_{dep} = 600^\circ\text{C}$ , 0-45 ML)

$b_c$ : critical base for the 2D-3D transition (from platelets to pyramids)

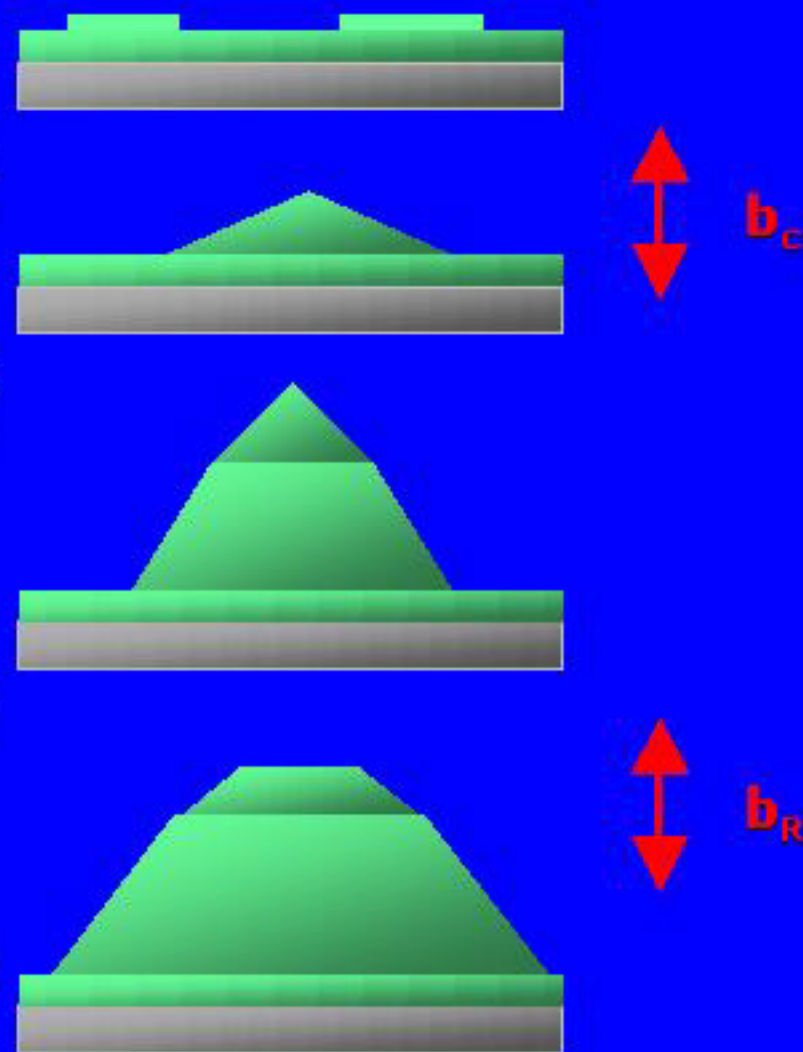
$b_R$ : inversion of the aspect ratio  $\alpha = h/b$  derivative with  $b$   
(from strained to relaxed domes)

# Ge/Si(100) self assembling

The growth dynamics evolves through metastable states



- Platelets
- ▲ Piramys
- ▲ Strained Domes
- Relaxed Domes
- + Overall



# Ge/Si(100) self assembling

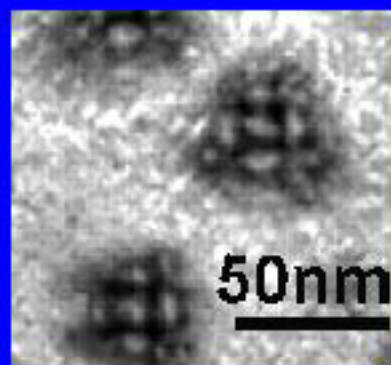
Searching for morphology-strain evolution during the growth: why the aspect ratio increases

From TEM

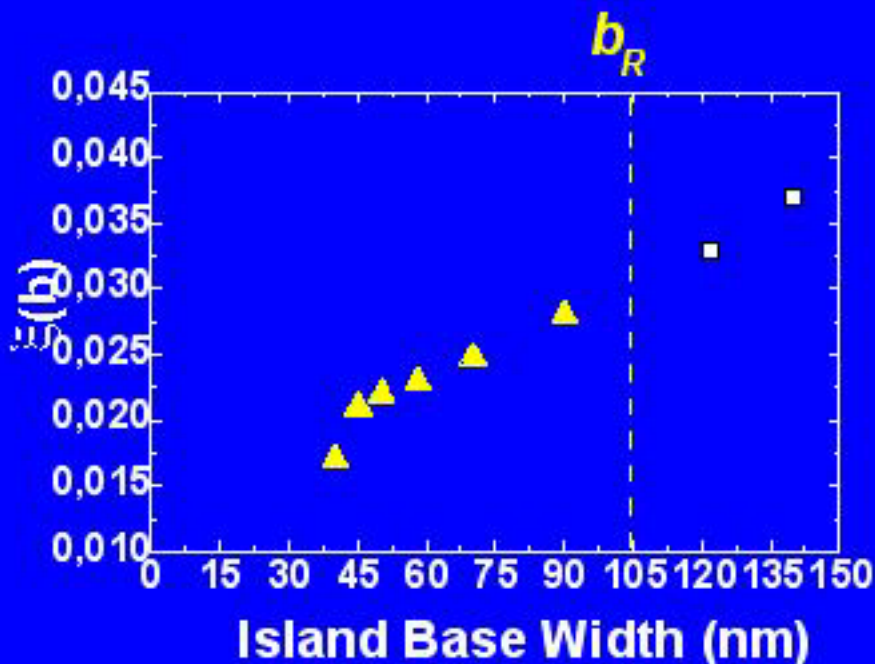
(two beams [220])



$\xi = d_{Si} / (\Delta - d_{Si})$  : lattice mismatch



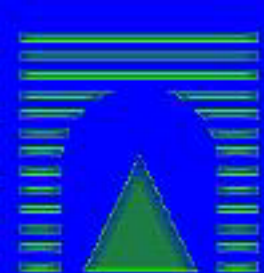
Measurement performed on a choice of individual island of a given size, no intermixing is assumed (verify later on:  $T=500^\circ\text{C}$ )



Increasing the island size (i.e.  $\alpha$ ) the lattice planes are allowed to bend: nearly complete elastic relaxation



$\xi = \epsilon_0$



# Ge/Si(100) self assembling

The 3D growth allows strain energy relaxation

$$E_{st} = C(\Phi(\alpha) \cdot \epsilon)^2$$

C: elastic constant

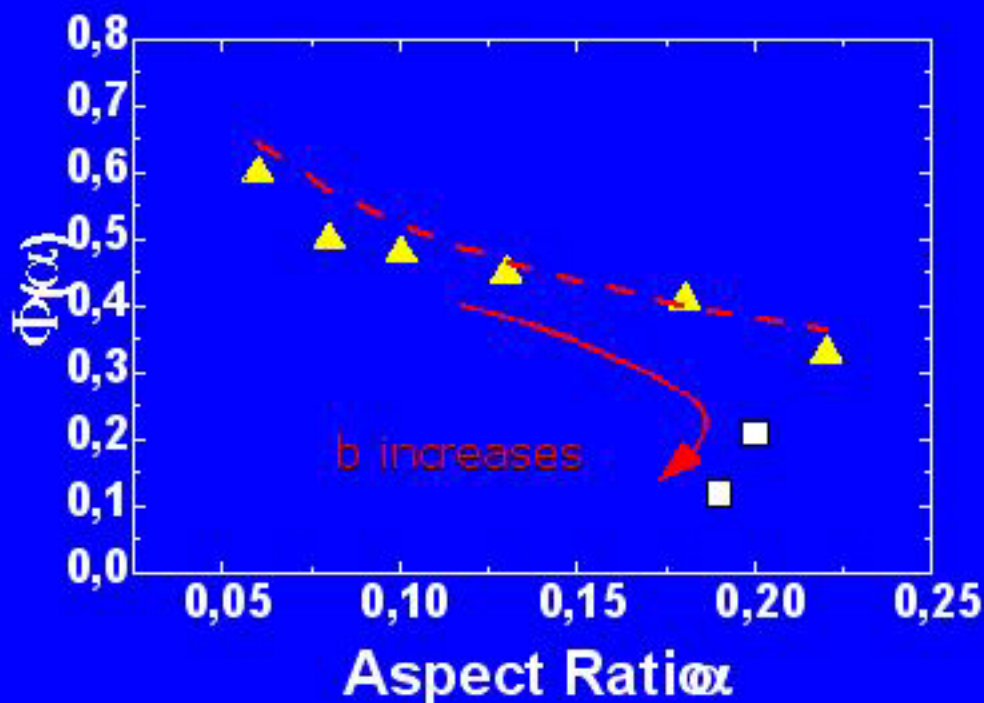
$\Phi(\alpha)$ : relaxation function

$\epsilon$ : heterostructure misfit

(no intermixing then  $\epsilon = 4.2\%$ )

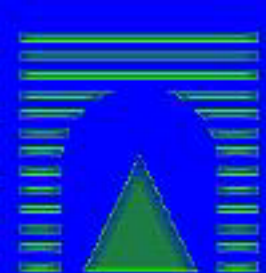
$$\Phi(\alpha) = 1 - \xi(b(\alpha)) / \epsilon$$

$b(\alpha)$  obtained from AFM



Agreement with the theory:  
Christiansen et al., APL 66, 574 (1995).

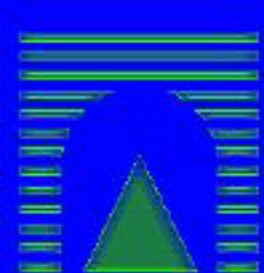
- We can derive the universal function  $\Phi(\alpha)$  for strain relaxation.
- MDs insertion implies change in the  $\alpha$  ( $b$ ) behavior.
- The chosen  $b_R$  is the critical base for MD insertion



## Ge/Si(100) self assembling

- Well defined pathway toward the equilibrium shape.
- Energy relaxation-shape evolution evidenced.
- Parameters  $b_C$   $b_R$  have been defined.

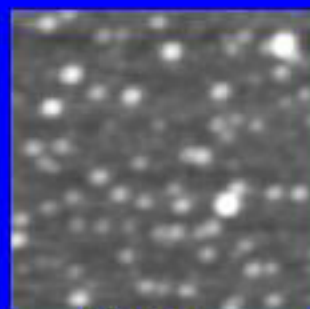




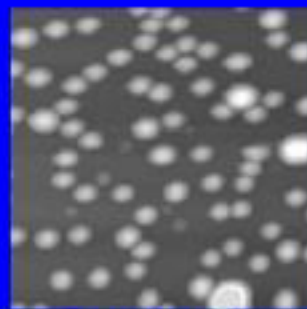
# The role of the deposition temperature

Constant growth rate and coverage, variable  $T_{\text{dep}}$

( $F=10$  ML/min,  $\theta=12$  ML,  $T=450-850^\circ\text{C}$ )



500°C

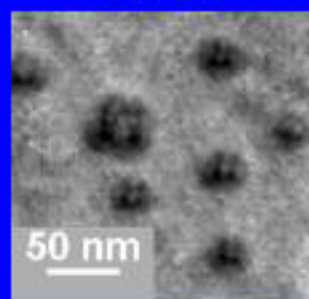


600°C

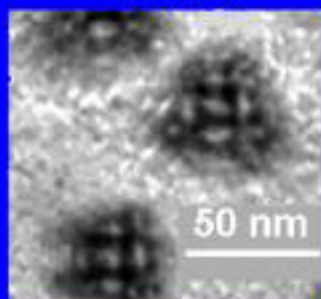


750°C

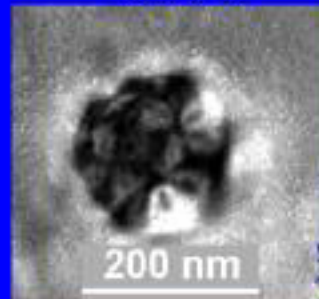
AFM  $1 \times 1 \mu\text{m}^2$



50 nm



50 nm

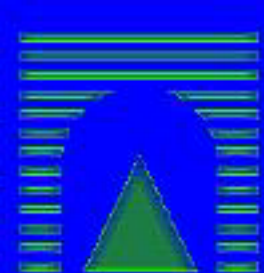


200 nm

HRTEM

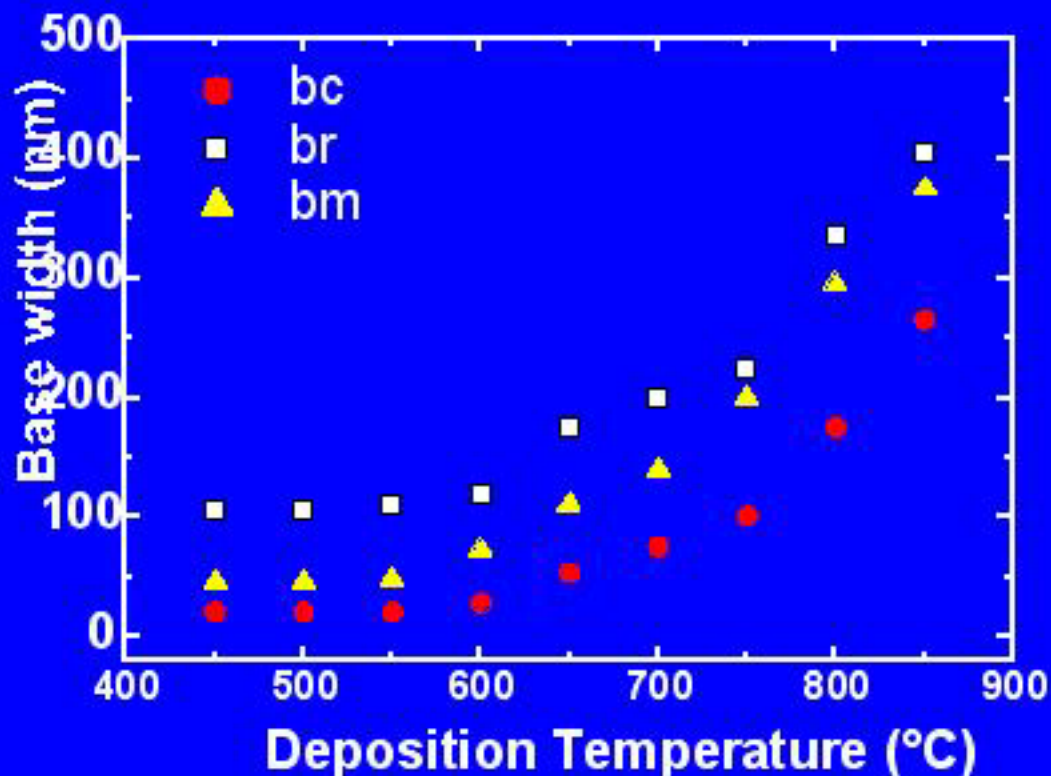
Upon increasing  $T_{\text{dep}}$  we observe:

- similar growth dynamics ( $b_C, b_R$  properly describe the system)
- typical sizes of each island family increases



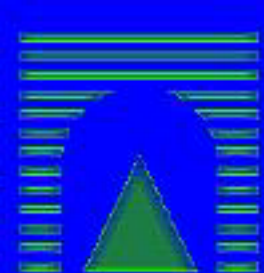
# The role of the deposition temperature

To be more quantitative.....



Above 550°C  $b_c$ ,  $b_R$ , and the average strained island base  $b_m$  increase: why?

SiGe INTERMIXING



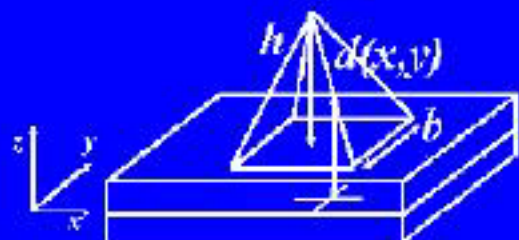
# The role of the deposition temperature

A new technique to measure island composition

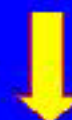
From AFM



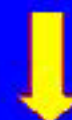
Sample Morphology



From XPS

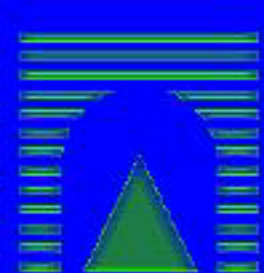


Ge, Si photoemitted currents



$$\int_{\text{Sample}} dI(x, y, z) = \int_{\text{Sample}} I_0 N_T \sigma_T e^{-\frac{d(x, y) - z}{\lambda_T}} dx dy dz$$

One can calculate the expected photoemitted current ratio  $R_{th}$  given the actual sample morphology



# The role of the deposition temperature

## We obtained

Capellini et al., Appl. Phys. Lett. **78**, 303(2001).

$$R_{Th} = \frac{\sigma_{Ge}}{\sigma_{Si}} \frac{x \left[ 1 - \frac{e^{-\frac{d_{vel}}{\lambda}}}{A} \left( \theta + 2 \sum_i b_i^2 \left( \frac{\lambda}{\alpha_i b_i} + \left( \frac{\lambda}{\alpha_i b_i} \right)^2 \left( e^{-\frac{\alpha_i b_i}{\lambda}} - 1 \right) \right) \right) \right]}{1 - x \left[ 1 - \frac{e^{-\frac{d_{vel}}{\lambda}}}{A} \left( \theta + 2 \sum_i b_i^2 \left( \frac{\lambda}{\alpha_i b_i} + \left( \frac{\lambda}{\alpha_i b_i} \right)^2 \left( e^{-\frac{\alpha_i b_i}{\lambda}} - 1 \right) \right) \right) \right]}$$

A: sample area

$\sigma$ : atomic cross section

x : average Ge contents

$\lambda$ : electron escape depth

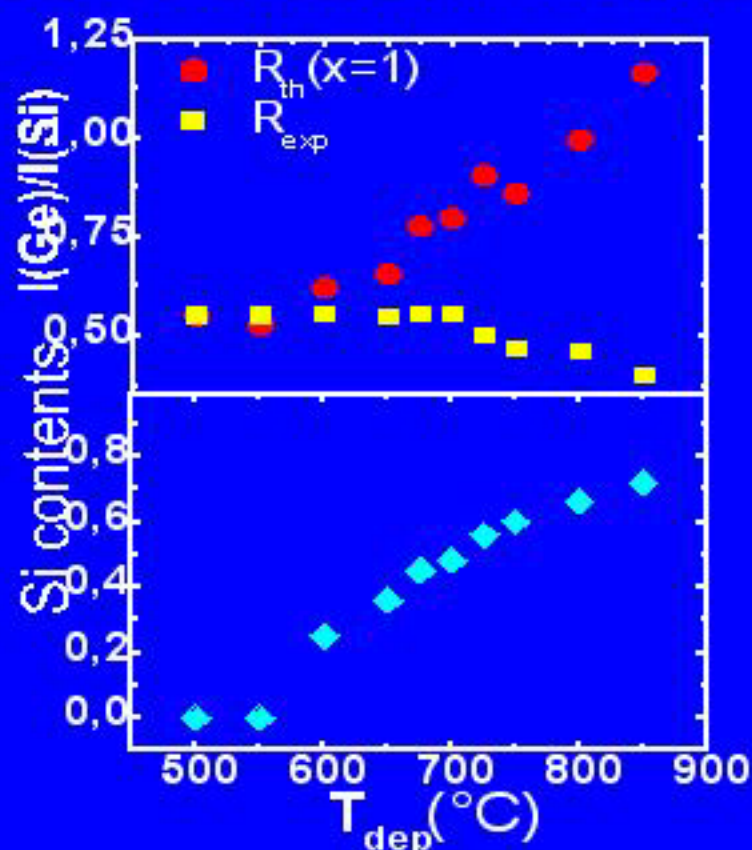
$b_i$ : i-th island base width

$\alpha_i$ : i-th island aspect ratio

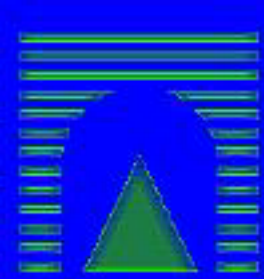
The x Ge content is the only fitting parameter

# The role of the deposition temperature

By comparing the experimental and the theoretical ratio one can obtain the actual sample composition



Strain driven, temperature enhanced intermixing is evidenced for  $T_{\text{dep}} > 550^\circ\text{C}$

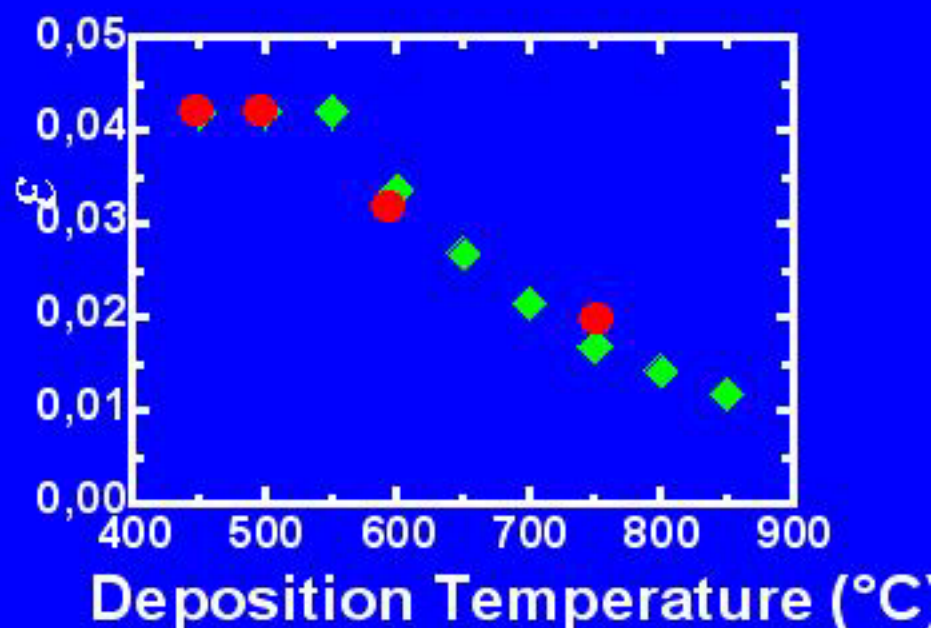


# The role of the deposition temperature

By means of a AFM/XPS technique we can evaluate the actual composition of the island layer and derive  $\epsilon = \epsilon_0 * X$ ,

Given the universality of  $\Phi(\alpha)$  obtained in the non-intermixed case (is only shape dependent), and measuring by TEM the lattice mismatch  $\xi$ , we can extract

$$\epsilon = \xi / (1 - \Phi(\alpha))$$

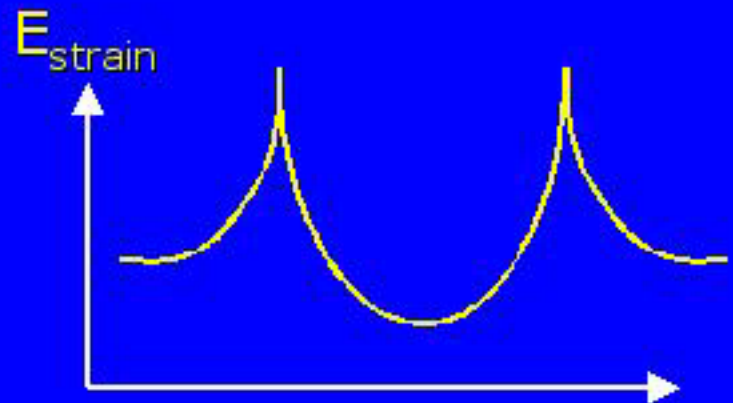


The main effect of the  $T_{dep}$  increase is to promote GeSi intermixing

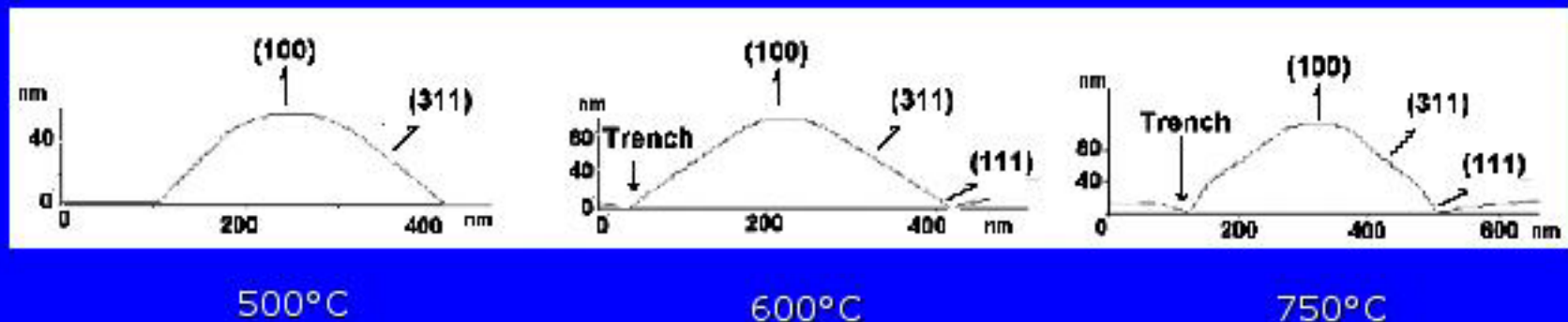
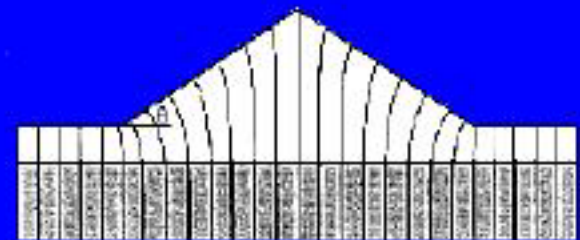
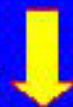
The higher the intermixing the lower the heterostructure effective misfit

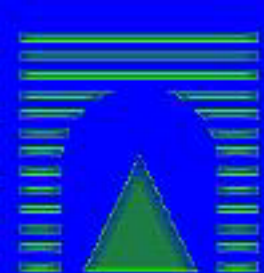
# The role of the deposition temperature

The intermixing offer an alternate way to reduce the strain energy, atom dragging from the substrate is enhanced



Trenches surrounding the islands at  $T_{\text{dep}} > 550^{\circ}\text{C}$





# The role of the deposition temperature

Island sizes scaling behavior with the effective misfit  $\varepsilon^{-\eta}$

## CALCULATED

- $b_c \sim \varepsilon^{-2}$

K.E. Khor et al.,  
JVSTB 15, 1051 ( 1997)

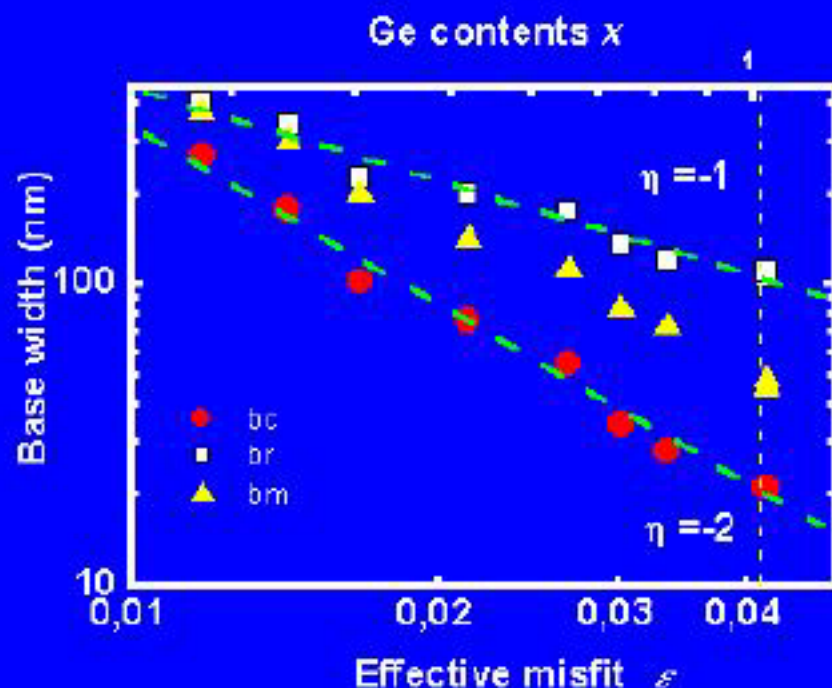
- $\langle b_m \rangle \sim \varepsilon^{-2}$

B. G. Orr et al,  
Ephys. Lett 19,33 (1992).

- $b_{cR} \sim \varepsilon^{-1}$

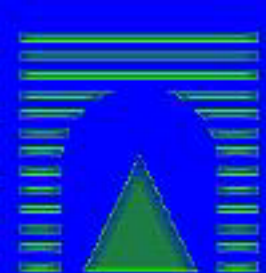
K. Tillmann et al.,  
Th.Sol.F. 368, 93 ( 2000)

## MEASURED



The island size enlargement is fully accounted by the measured intermixing driven misfit reduction





## Conclusion

- Ge/Si(100) self assembling:

  - Island growth dynamics described

  - Strain energy relaxation function obtained

- The role of the deposition temperature:

  - New technique to measure intermixing described

  - The temperature-induced misfit reduction well account for the observed island size scaling behaviour